

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Peak forward or reverse blocking current ⁽²⁾ ($V_{AK} = \text{Rated } V_{DRM} \text{ or } V_{RRM}, R_{GK} = 1k\Omega$) $T_C = 25^\circ\text{C}$ $T_C = 110^\circ\text{C}$	I_{DRM} I_{RRM}	- -	- -	10 500	μA
ON CHARACTERISTICS					
Peak forward on-state voltage ($I_{TM} = 16\text{A}$, pulse width $\leq 1\text{ms}$, duty cycle $\leq 2\%$)	V_{TM}	-	1.7	2.0	V
Gate trigger current (continuous dc) ⁽³⁾ ($V_D = 12\text{V}$, $R_L = 100\Omega$)	I_{GT}	-	30	200	μA
Gate trigger voltage (continuous dc) ⁽³⁾ ($V_D = 12\text{V}$, $R_L = 100\Omega$)	V_{GT}	-	0.5	1.5	V
Gate non-trigger voltage ($V_D = 12\text{V}$, $R_L = 100\Omega$, $T_J = 110^\circ\text{C}$)	V_{GD}	0.1	-	-	V
Holding current ($V_D = 12\text{V}$, gate open, initiating current = 200mA)	I_H	-	-	6.0	mA
Gate controlled turn-on time ($V_D = \text{Rated } V_{DRM}$, $I_{TM} = 16\text{A}$, $I_G = 2\text{mA}$)	t_{gt}	-	1.0	-	μs
DYNAMIC CHARACTERISTICS					
Critical rate of rise of off-state voltage ($V_D = \text{rated } V_{DRM}$, $R_{GK} = 1k\Omega$, $T_J = 110^\circ\text{C}$, exponential waveform)	dv/dt	-	10	-	V/ μs

THERMAL CHARACTERISTICS

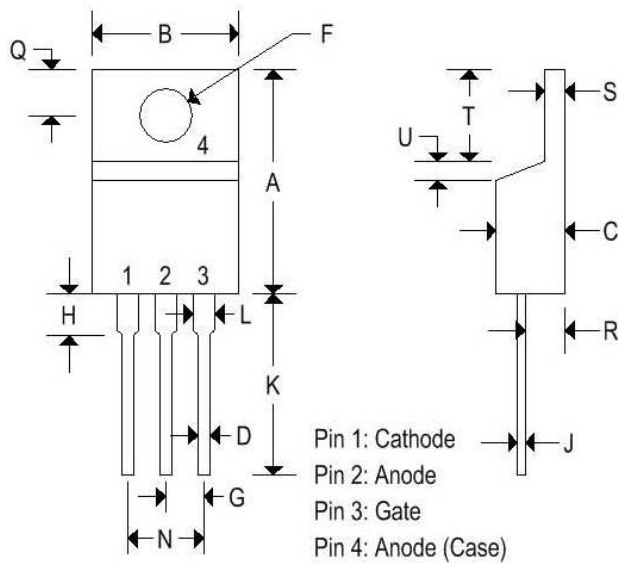
Characteristic	Symbol	Maximum	Unit
Thermal resistance, junction to case	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS					
Peak forward or reverse blocking current ($V_{AK} = \text{Rated } V_{DRM} \text{ or } V_{RRM}, \text{ gate open}$) $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$	I_{DRM} or I_{RRM}	- -	- -	10 2.0	μA mA
ON CHARACTERISTICS					
Peak forward on-state voltage ($I_{TM} = 24\text{A peak}$)	V_{TM}	-	1.7	2.2	Volts
Gate trigger current (continuous dc) ($V_D = 12\text{ Vdc}, R_L = 100\ \Omega$)	I_{GT}	-	5.0	30	mA
Gate trigger voltage (continuous dc) ($V_D = 12\text{ Vdc}, R_L = 100\ \Omega$)	V_{GT}	-	0.7	1.5	Volts
Gate non-trigger voltage ($V_D = \text{Rated } V_{DRM}, R_L = 100\ \Omega, T_J = 125^\circ\text{C}$)	V_{GD}	0.2	-	-	Volts
Holding current ($V_D = 12\text{Vdc}$)	I_H	-	6.0	40	mA
Turn on time ($I_{TM} = 12\text{A}, I_{GT} = 40\text{mAdc}, V_D = \text{rated } V_{DRM}$)	t_{gt}	-	1.0	2.0	μs
Turn-off time ($V_D = \text{rated } V_{DRM}$) ($I_{TM} = 12\text{A}, I_R = 12\text{A}$) ($I_{TM} = 12\text{A}, I_R = 12\text{A}, T_J = 125^\circ\text{C}$)	t_q	- -	15 35	- -	μs
DYNAMIC CHARACTERISTICS					
Critical rate of rise of off-state voltage exponential ($V_D = \text{rated } V_{DRM}, T_J = 125^\circ\text{C}$)	dv/dt	-	50	-	$\text{V}/\mu\text{s}$

MECHANICAL CHARACTERISTICS

Case:	TO-220AB
Marking:	Body painted, alpha-numeric
Pin out:	See below



	TO-220AB			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.575	0.620	14.600	15.750
B	0.380	0.405	9.650	10.290
C	0.160	0.190	4.060	4.820
D	0.025	0.035	0.640	0.890
F	0.142	0.147	3.610	3.730
G	0.095	0.105	2.410	2.670
H	0.110	0.155	2.790	3.930
J	0.014	0.022	0.360	0.560
K	0.500	0.562	12.700	14.270
L	0.045	0.055	1.140	1.390
N	0.190	0.210	4.830	5.330
Q	0.100	0.120	2.540	3.040
R	0.080	0.110	2.040	2.790
S	0.045	0.055	1.140	1.390
T	0.235	0.255	5.970	6.480
U	-	0.050	-	1.270
V	0.045	-	1.140	-
Z	-	0.080	-	2.030

Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Off State Forward Voltage
I_{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Off State Reverse Voltage
I_{RRM}	Peak Reverse Blocking Current
V_{TM}	Peak On State Voltage
I_H	Holding Current

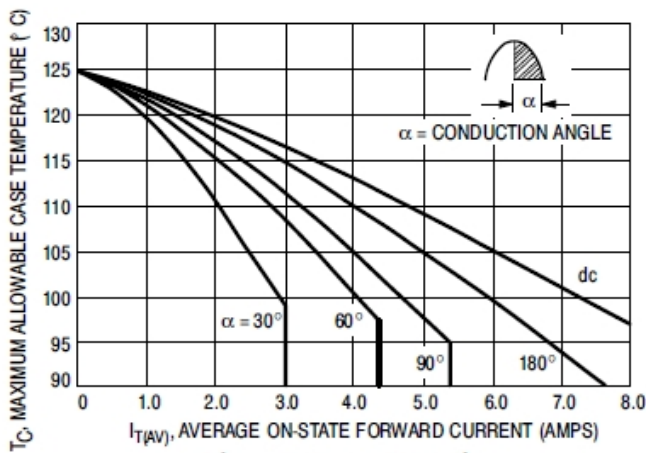
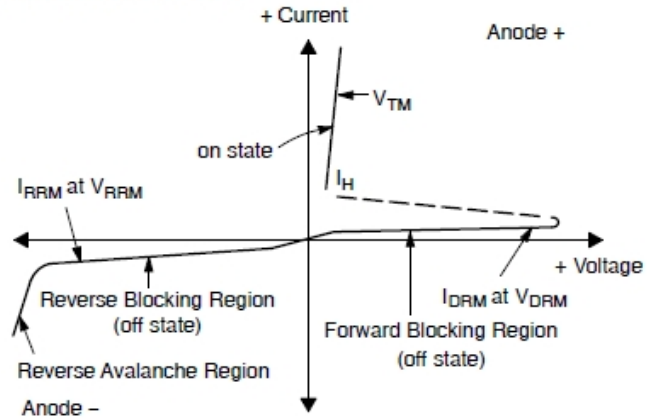


Figure 1. Current Derating

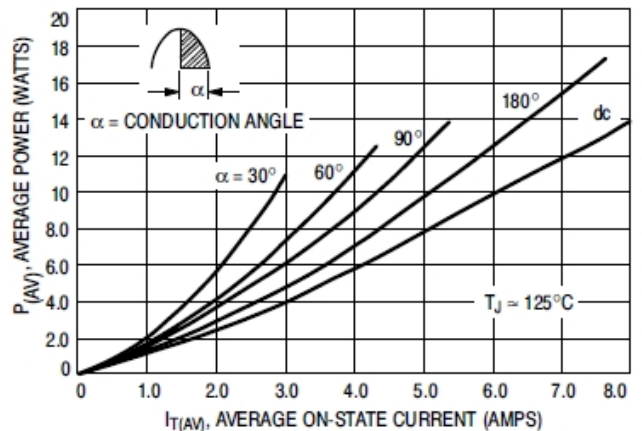


Figure 2. Maximum On-State Power Dissipation

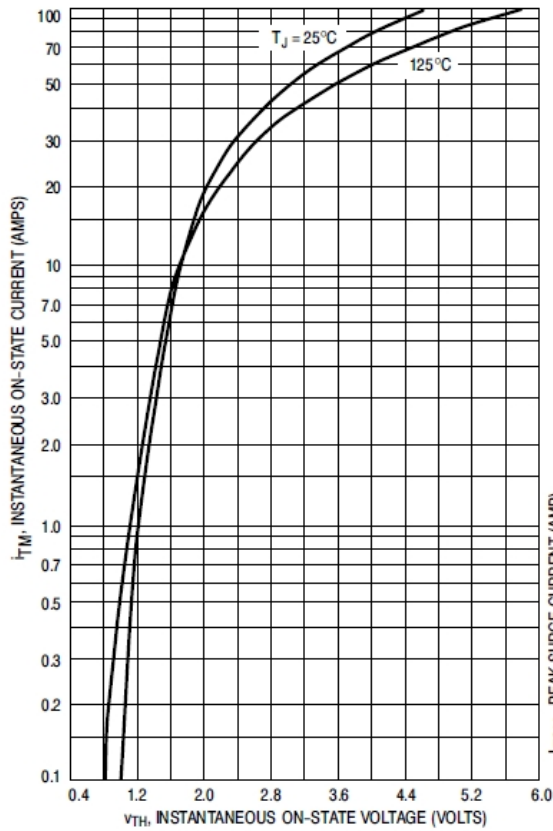


Figure 3. On-State Characteristics

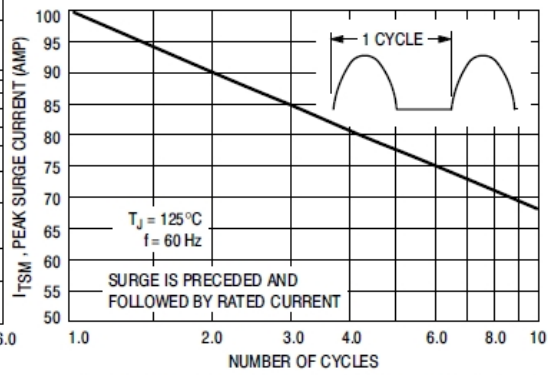


Figure 4. Maximum Non-Repetitive Surge Current

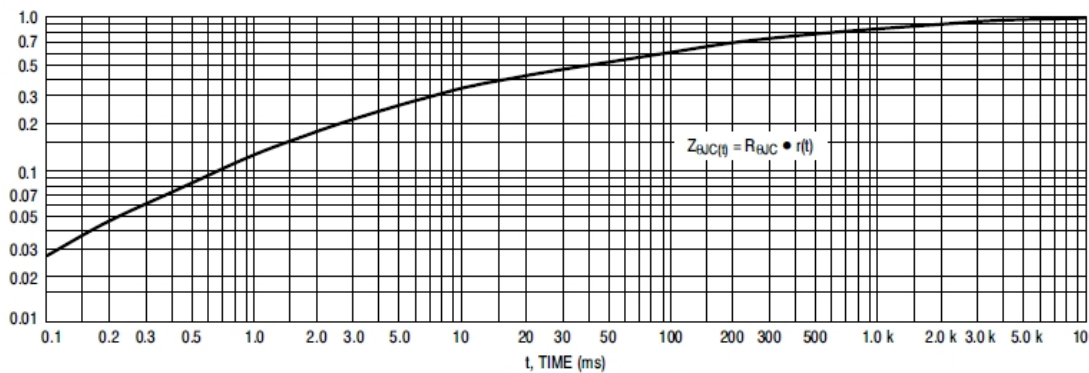
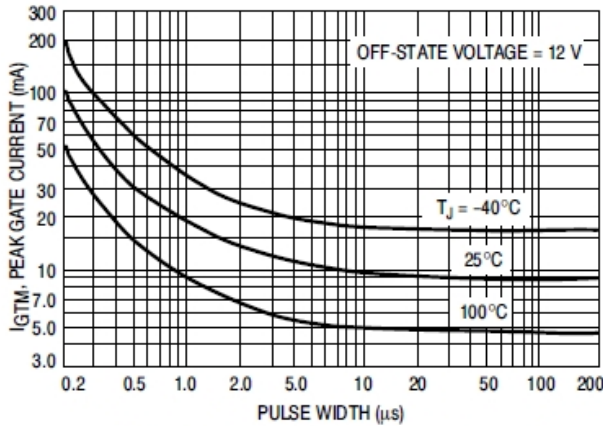
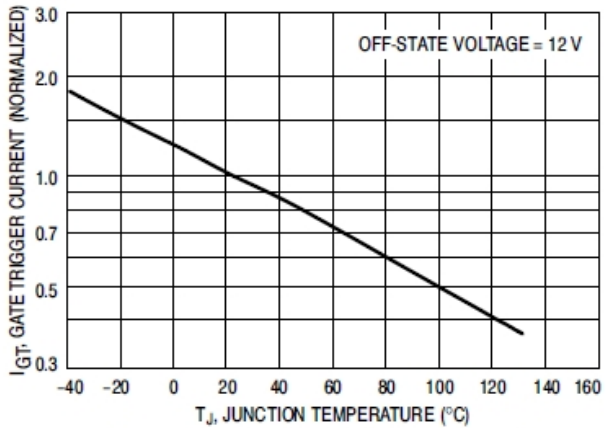


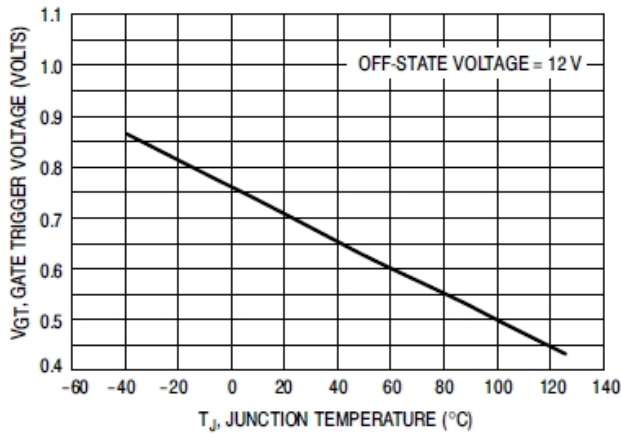
Figure 5. Thermal Response



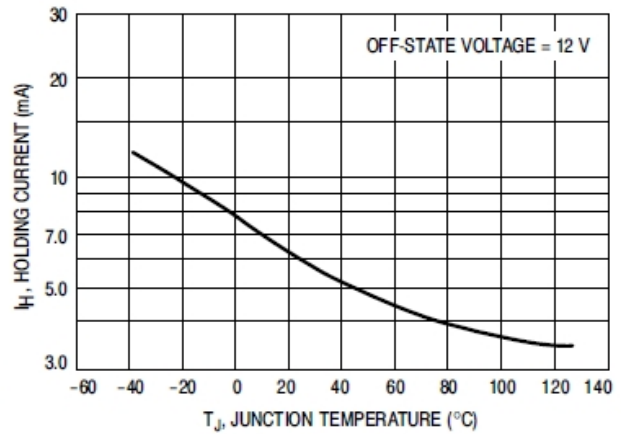
**Figure 6. Typical Gate Trigger Current
versus Pulse Width**



**Figure 7. Typical Gate Trigger Current
versus Temperature**



**Figure 8. Typical Gate Trigger Voltage
versus Temperature**



**Figure 9. Typical Holding Current
versus Temperature**